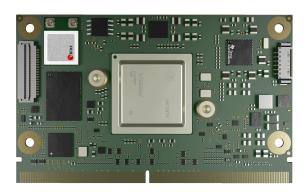
Form factor

## TI Jacinto™ 7 SMARC – Accelerated Computing

## conga-STDA4



SMARC Module Specification 2.1

- SMARC Module based on TI Jacinto™ 7 Processors TDA4VM and DRA829
- Heterogenous architecture with dual Arm® Cortex®-A72,
   DSP and accelerators for deep learning and multimedia
- Arm® Cortex®-R5F MCUs to offload real-time communication
- Highest reliability for harsh environment applications
- Industrial temperature range -40°C ... +85°C

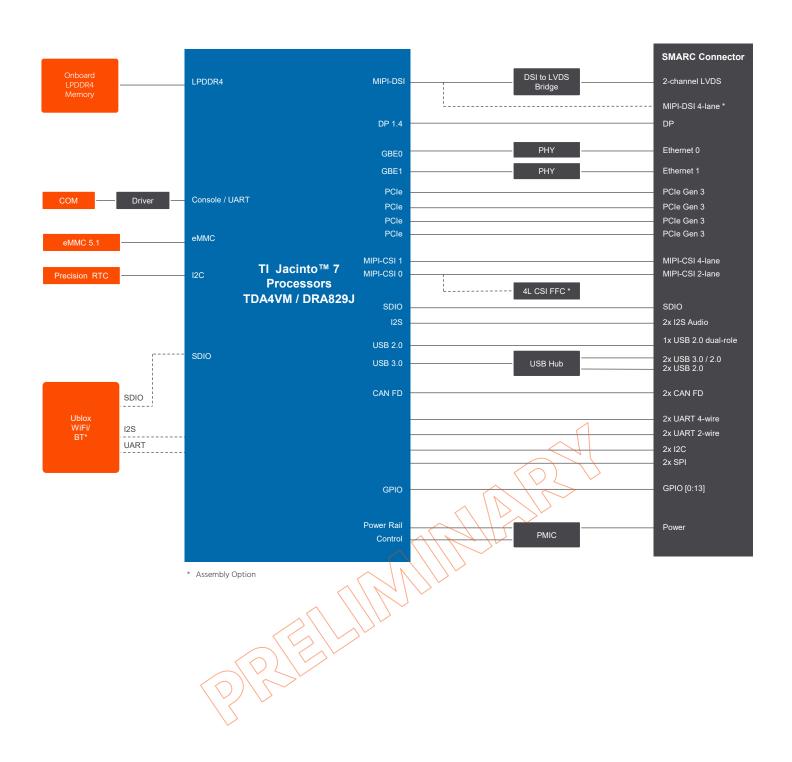


CPU SoC	TI Jacinto™ 7 Processors						
	TDA4VM DRA829J	ARM Cortex-A72 2x @ 2.0 GHz 2x @ 2.0 GHz	ARM Cortex-R5F 6x @ 1.0 GHz 6x @ 1.0 GHz	DSP Cores 1x C7x up to 80 GFLOPs 2x C66 up to 40 GFLOPs	<b>MMA</b> Deep Learning Up to 8 TOPS	<b>GPU</b> 3D PowerVR Rogue 8XE GE8430	
DRAM	Up to 8 GB onboard LPDDR4x memory   3733 MT/s   inline ECC Up to 8 MB of on-chip L3 RAM with ECC and coherency   512KB on-chip SRAM in MAIN domain, protected by ECC						
Ethernet	2x Gbit Ethernet with IEEE 1588 support						
I/O Interfaces	1x dual-role USB 2.0   2x USB 2.0   2x USB 3.0   1x SDIO 3.0   2x PCle 3.0 x1 + 1x PCle 3.0 x2 or up to 4x PCle 3.0 x1   2x GP I <sup>2</sup> C   2x SPI   4x UART (2x with Handshake)   2x CAN FD   14x GPIO   optional full industrial onboard Uplox WiFi/BT module						
Mass Storage	eMMC 5.1 up to 128 GB configurable as pseudo-SLC						
Sound	2x I <sup>2</sup> S						
Graphics	Integrated in SoC   Graphics Accelerator 3D GPU PowerVR Rogue 8XE GE8430   up to 1x Ultra-HD or 4x Full-HD 60fps display resolution   Up to 2 independent display outputs   VPU up to 4k60p H.264 encode / Full-HD H.265 decode   OpenGL ES 3.1   Open VX   OpenCL						
Video Interfaces	1x dual channel 24-bit LVDS   1x Display Port 1.4 supports up to 3 Full HD 1080p displays via MST   optional 1x MIPI-DSI 4-lane shared with LVDS   2x MIPI-CSI 4-lanes   2x integrated Image Signal Processor (ISP) for MIPI-CSI camera						
Features	Watchdog Timer   Console Port   High Precision Real Time Clock						
AI & Deep Learning	Deep-learning Matrix Multiply Accelerator Accelerators (MMA) with up to 8 TOPS   C7x floating point, vector DSP with up to 80GFLOPs   Vision Processing Accelerators (VPAC) with Image Signal Processor (ISP) and multiple vision assist accelerators   Depth and Motion Processing Accelerators (DMPAC)						
Security	Customer programmable root key, up to RSA-4K or ECC-512   Crypto hardware accelerators, PKA with ECC, AES, SHA, RNG, DES and 3DES   High Assurance Boot support (optional)   SHE, Encryption Engine AES-128, AES-256, TRNG, SHA-1, SHA-2, SHA-256, MD-5   RSA-1024, 2048, 3072, 4096 and secure key storage						
Boot Loader	U-Boot boot loader						
Operating Systems	Linux   QNX   RTOS   VxWorks						
Power Consumption	Typ. application 5-10W @ 5V						
Temperature Range	1 2	emperature Range: nperature Range:	-40 to +85°C ind -40 to +85°C	dustrial grade			
Humidity	Operating: 1	0 - 90% r. H. non cond.	Storage: 5 - 95%	6 r. H. non cond.			
Size	82 x 50 mm (3,23" x 1,97")						





## conga-STDA4 | Block Diagram





## conga-STDA4 | Order Information

Article	PN	Description			
conga-STDA4/i-TDA4VM-4G eMMC32	051510	SMARC Module based on high-performance industrial TI ARM Jacinto 7 ARM processor TDA4VM. Features 2x ARM Cortex-A72 @ 2.0GHz + 6x ARM Cortex-R5F + 8 TOPS MMA (deep-learning matrix multiply accelerator), 4GB onboard LPDDR4x memory and 32GB onboard eMMC. Industrial grade temperature range from -40°C to 85°C.			
conga-STDA4/i-TDA4VM-2G eMMC32	051511	SMARC Module based on high-performance industrial TI ARM Jacinto 7 ARM processor TDA4VM Features 2x ARM Cortex-A72 @ 2.0GHz + 6x ARM Cortex-R5F + 8 TOPS MMA (deep-learning matrix multiply accelerator), 2GB onboard LPDDR4x memory and 32GB onboard eMMC. Industrial grade temperature range from -40°C to 85°C.			
conga-STDA4/i-DRA829J-4G eMMC32	051512	SMARC Module based on high-performance industrial TI ARM Jacinto 7 ARM networking processor DRA829. Features 2x ARM Cortex-A72 @ 2.0GHz + 6x ARM Cortex-R5F, 4GB onboard LPDDR4x memory and 32GB onboard eMMC. Industrial grade temperature range from -40°C to 85°C.			
conga-STDA4/i-DRA829J-2G eMMC32	051513	SMARC Module based on high-performance industrial TI ARM Jacinto 7 ARM networking processor DRA829. Features 2x ARM Cortex-A72 @ 2.0GHz + 6x ARM Cortex-R5F, 2GB onboard LPDDR4x memory and 32GB onboard eMMC. Industrial grade temperature range from -40°C to 85°C			
conga-STDA4/CSP-B	051550	Passive cooling solution for SMARC Module conga-STDA4 based on TI ARM Jacinto 7 ARM processor. All standoffs are with 2.7 mm bore hole.			
conga-STDA4/HSP-B	051551	Standard heats preader for SMARC Module conga-STDA4 based on TI ARM Jacinto 7 ARM processor. All standoffs are with 2.7 mm bore hole.			
SMARC/CSA Adapter 050060		Active cooling solution adapter for SMARC modules used in combination with module heat spreader.			
conga-SEVAL	007010	Evaluation carrier board for SMARC modules.			
conga-SMC1/SMARC-ARM	020750	3.5" carrier board for congatec SMARC modules based on ARM architecture.			





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